

Radiation Hardened 4-Bit Magnitude Comparator

December 1992

Features

- 3 Micron Radiation Hardened SOS CMOS
- Total Dose 200K or 1 Mega-RAD (SI)
- Dose Rate Upset $>10^{10}$ RAD(Si)/s 20ns Pulse
- Cosmic Ray Upset Rate $< 2 \times 10^{-9}$ Errors/Bit Day
- Latch-Up Free Under Any Conditions
- Fanout (Over Temperature Range)
 - Standard Outputs 10 LSTTL Loads
- Military Temperature Range -55°C to +125°C
- Significant Power Reduction Compared to LSTTL ICs
- DC Operating Voltage Range 4.5V to 5.5V
- LSTTL Input Compatibility
 - VIL = 0.8V Max
 - VIH = VCC/2 Min
- Input Current Levels II $\leq 5\mu A$ at VOL, VOH

Description

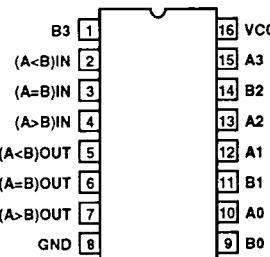
The Harris HCTS85MS is a Radiation Hardened 4-bit high speed magnitude comparator. This device compares two binary, BCD, or other monotonic codes and presents the three possible magnitude results at the outputs (A>B, A<B, and A=B). The 4-bit input words are weighted (A0 to A3 and B0 to B3), where A3 and B3 are the most significant bits. The HCTS85MS is expandable without external gating, both serial and parallel operation.

The HCTS85MS utilizes advanced CMOS/SOS technology to achieve high-speed operation. This device is a member of radiation hardened, high-speed, CMOS/SOS Logic Family with TTL input compatibility.

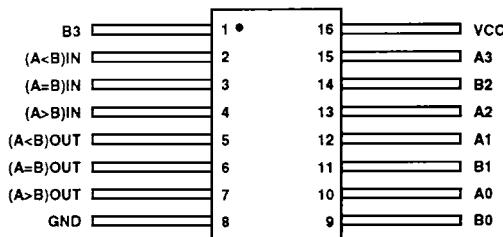
The HCTS85MS is supplied in a 16 lead Weld Seal Ceramic flatpack (K suffix) or a Weld Seal Ceramic Dual-In-Line Package (D suffix).

Pinouts

16 PIN CERAMIC DUAL-IN-LINE
MIL-STD-1835 DESIGNATOR CDIP2-T16, LEAD FINISH C
TOP VIEW



16 PIN CERAMIC FLAT PACK
MIL-STD-1835 DESIGNATOR CDFP4-F16, LEAD FINISH C
TOP VIEW



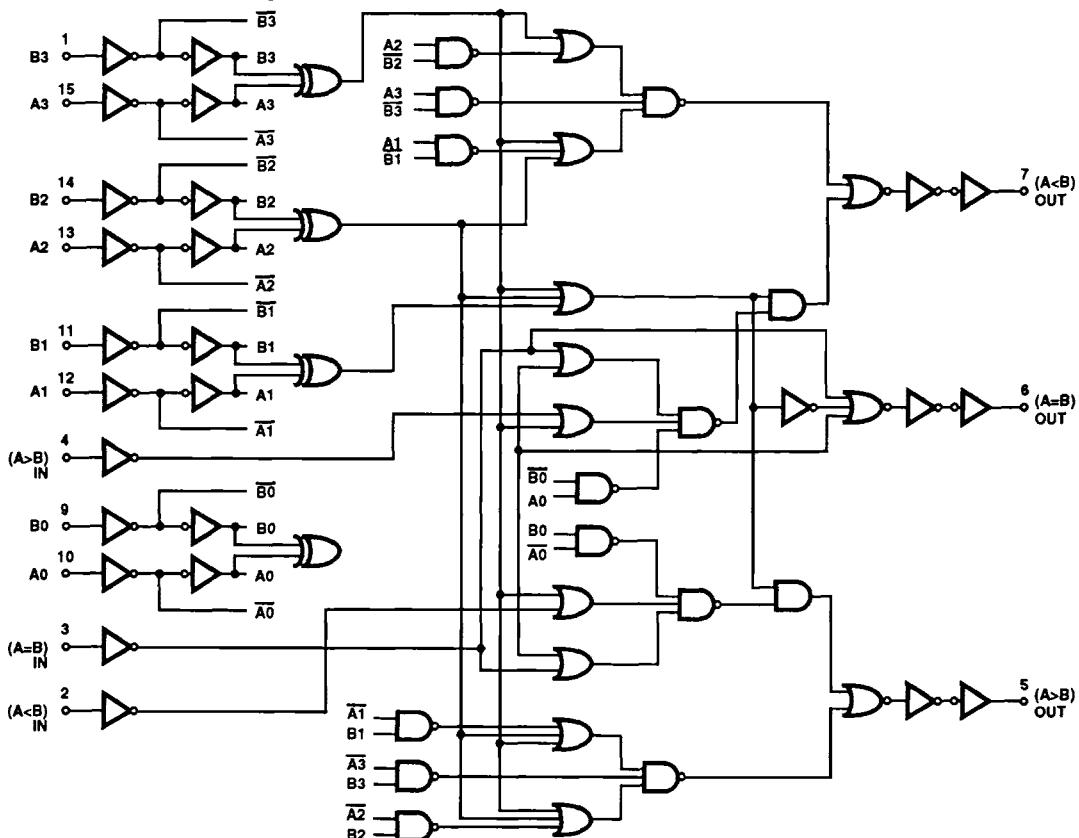
Truth Table

COMPARING INPUTS				CASCADING INPUTS			OUTPUTS		
A3, B3	A2, B2	A1, B1	A0, B0	A>B	A<B	A=B	A>B	A<B	A=B
A3>B3	X	X	X	X	X	X	H	L	L
A3<B3	X	X	X	X	X	X	L	H	L
A3=B3	A2>B2	X	X	X	X	X	H	L	L
A3=B3	A2<B2	X	X	X	X	X	L	H	L
A3=B3	A2=B2	A1>B1	X	X	X	X	H	L	L
A3=B3	A2=B2	A1<B1	X	X	X	X	L	H	L
A3=B3	A2=B2	A1=B1	A0>B0	X	X	X	H	L	L
A3=B3	A2=B2	A1=B1	A0<B0	X	X	X	L	H	L
A3=B3	A2=B2	A1=B1	A0=B0	H	L	L	H	L	L
A3=B3	A2=B2	A1=B1	A0=B0	L	H	L	L	H	L
A3=B3	A2=B2	A1=B1	A0=B0	L	L	H	L	L	H
A3=B3	A2=B2	A1=B1	A0=B0	X	X	H	L	L	H
A3=B3	A2=B2	A1=B1	A0=B0	H	H	L	L	L	L
A3=B3	A2=B2	A1=B1	A0=B0	L	L	L	H	H	L

Single Device
OR
Series Cascading

Parallel Cascading

NOTE: L = Logic Level Low, H = Logic Level High, X = Immaterial

Functional Block Diagram

Specifications HCTS85MS

Absolute Maximum Ratings

Supply Voltage (VCC)	-0.5V to +7.0V
Input Voltage Range, All Inputs	-0.5V to VCC +0.5V
DC Input Current, Any One Input	±10mA
DC Drain Current, Any One Output	±25mA
(All Voltage Reference to the VSS Terminal)	
Storage Temperature Range (TSTG)	-65°C to +150°C
Lead Temperature (Soldering 10sec)	+265°C
Junction Temperature (TJ)	+175°C
ESD Classification	Class 1

CAUTION: As with all semiconductors, stress listed under "Absolute Maximum Ratings" may be applied to devices (one at a time) without resulting in permanent damage. This is a stress rating only. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. The conditions listed under "Electrical Performance Characteristics" are the only conditions recommended for satisfactory device operation.

Reliability Information

Thermal Impedance	θ_{JA}	θ_{JC}
Weld Seal DIC	75°C/W	16°C/W
Weld Seal Flat Pack.	64°C/W	12°C/W
Power Dissipation per Package (PD)		
For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$		1W
For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$		Derate Linearly at 13mW/ $^\circ\text{C}$

Operating Conditions

Supply Voltage (VCC)	+4.5V to +5.5V	Input Low Voltage (VIL)	0.0V to 0.8V
Operating Temperature Range (T_A)	-55°C to +125°C	Input High Voltage (VIH)	2.0V to VCC
Input Rise and Fall Times at VCC = 4.5V (TR, TF)	500ns Max.		

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETERS	SYMBOL	(NOTE 1) CONDITIONS	GROUP A SUB- GROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Quiescent Current	ICC	VCC = 5.5V, VIN = VCC or GND	1	+25°C	-	40	µA
			2, 3	+125°C, -55°C	-	750	µA
Output Current (Sink)	IOL	VCC = 4.5V, VIH = 4.5V, VOUT = 0.4V, VIL = 0V	1	+25°C	4.8	-	mA
			2, 3	+125°C, -55°C	4.0	-	mA
Output Current (Source)	IOH	VCC = 4.5V, VIH = 4.5V, VOUT = VCC - 0.4V, VIL = 0V	1	+25°C	-4.8	-	mA
			2, 3	+125°C, -55°C	-4.0	-	mA
Output Voltage Low	VOL	VCC = 4.5V, VIH = 2.25V, IOL = 50µA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	-	0.1	V
		VCC = 5.5V, VIH = 2.75V, IOL = 50µA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	-	0.1	V
Output Voltage High	VOH	VCC = 4.5V, VIH = 2.25V, IOH = -50µA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	VCC -0.1	-	V
		VCC = 5.5V, VIH = 2.75V, IOH = -50µA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	VCC -0.1	-	V
Input Leakage Current	IIN	VCC = 5.5V, VIN = VCC or GND	1	+25°C	-0.5	+0.5	µA
			2, 3	+125°C, -55°C	-5.0	+5.0	µA
Noise Immunity Functional Test	FN	VCC = 4.5V, VIH = 2.25V, VIL = 0.8V (Note 2)	7, 8A, 8B	+25°C, +125°C, -55°C	-	-	-

NOTES:

1. All voltages referenced to device GND.
2. For functional tests, $VO \geq 4.0V$ is recognized as a logic "1", and $VO \leq 0.5V$ is recognized as a logic "0".

Specifications HCTS85MS

TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETER	SYMBOL	(NOTES 1, 2) CONDITIONS	GROUP A SUB- GROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
An to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	36	ns
			10, 11	+125°C, -55°C	2	43	ns
Bn to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	57	ns
			10, 11	+125°C, -55°C	2	66	ns
An, Bn to (A<B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	45	ns
			10, 11	+125°C, -55°C	2	51	ns
An, Bn to (A=B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	42	ns
			10, 11	+125°C, -55°C	2	50	ns
An, Bn to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	29	ns
			10, 11	+125°C, -55°C	2	35	ns
(A>B)IN to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	34	ns
			10, 11	+125°C, -55°C	2	39	ns
(A=B)IN to (A=B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	28	ns
			10, 11	+125°C, -55°C	2	37	ns
(A<B)IN to (A<B)OUT	TPHL, TPLH	VCC = 4.5V	9	+25°C	2	29	ns
			10, 11	+125°C, -55°C	2	35	ns

NOTES:

1. All voltages referenced to device GND.
2. AC measurements assume RL = 500Ω, CL = 50pF, Input TR = TF = 3ns, VIL = GND, VIH = 3V.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Capacitance Power Dissipation	CPD	VCC = 5.0V, f = 1MHz	1	+25°C	Typical 26		pF
			1	+125°C, -55°C	Typical 61		pF
Input Capacitance	CIN	VCC = Open, f = 1MHz	1	+25°C	-	10	pF
			1	+125°C, -55°C	-	10	pF
Output Transition Time	TTHL, TTLH	VCC = 4.5V	1	+25°C	-	15	ns
			1	+125°C, -55°C	-	22	ns

NOTES:

1. The parameters listed in Table 3 are controlled via design or process parameters. Min and Max Limits are guaranteed but not directly tested. These parameters are characterized upon initial design release and upon design changes which affect these characteristics.

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TABLE 4. DC POST RADIATION ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETERS	SYMBOL	(NOTES 1, 2) CONDITIONS	TEMPERATURE	200K RAD LIMITS		1M RAD LIMITS		UNITS
				MIN	MAX	MIN	MAX	
Quiescent Current	ICC	VCC = 5.5V, VIN = VCC or GND	+25°C	-	0.750	-	2.0	mA
Output Current (Sink)	IOL	VCC = 4.5V, VIN = VCC or GND, VOUT = 0.4V	+25°C	4.0	-	4.0	-	mA
Output Current (Source)	IOH	VCC = 4.5V, VIN = VCC or GND, VOUT = VCC -0.4V	+25°C	-4.0	-	-4.0	-	mA
Output Voltage Low	VOL	VCC = 4.5V and 5.5V, VIH = VCC/ 2, VIL = 0.8V at 200K RAD, VIL = 0.3V at 1M RAD, IOL = 50µA	+25°C	-	0.1	-	0.1	V
Output Voltage High	VOH	VCC = 4.5V and 5.5V, VIH = VCC/ 2, VIL = 0.8V at 200K RAD, VIL = 0.3V at 1M RAD, IOH = -50µA	+25°C	VCC -0.1	-	VCC -0.1	-	V
Input Leakage Current	IIN	VCC = 5.5V, VIN = VCC or GND	+25°C	-5	+5	-5	+5	µA
Noise Immunity Functional Test	FN	VCC = 4.5V, VIH = 2.25V, VIL = 0.8V at 200K RAD, VIL = 0.3V at 1M RAD (Note 3)	+25°C	-	-	-	-	-
An to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	43	2	82	ns
Bn to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	66	2	48	ns
An, Bn to (A<B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	51	2	63	ns
An, Bn to (A=B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	50	2	62	ns
(A<B)IN to (A<B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	35	2	43	ns
(A>B)IN to (A>B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	39	2	48	ns
(A=B)IN to (A=B)OUT	TPHL, TPLH	VCC = 4.5V	+25°C	2	37	2	41	ns

NOTES:

1. All voltages referenced to device GND.
2. AC measurements assume RL = 500Ω, CL = 50pF, Input TR = TF = 3ns, VIL = GND, VIH = 3V.
3. For functional tests VO ≥ 4.0V is recognized as a logic "1", and VO ≤ 0.5V is recognized as a logic "0".

TABLE 5. BURN-IN AND OPERATING LIFE TEST, DELTA PARAMETERS (+25°C)

PARAMETER	GROUP B SUBGROUP	DELTA LIMIT
ICC	5	12µA
IOL/IOH	5	-15% of 0 Hour

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TABLE 6. APPLICABLE SUBGROUPS

CONFORMANCE GROUPS		METHOD	GROUP A SUBGROUPS	READ AND RECORD
Initial Test (Preburn-In)		100%/5004	1, 7, 9	ICC, IOL/H
Interim Test I (Postburn-In)		100%/5004	1, 7, 9	ICC, IOL/H
Interim Test II (Postburn-In)		100%/5004	1, 7, 9	ICC, IOL/H
PDA		100%/5004	1, 7, 9, Deltas	
Interim Test III (Postburn-In)		100%/5004	1, 7, 9	
PDA		100%/5004	1, 7, 9, Deltas	
Final Test		100%/5004	2, 3, 8A, 8B, 10, 11	
Group A (Note 1)		Sample/5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11	
Group B	Subgroup B-5	Sample/5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11, Deltas	Subgroups 1, 2, 3, 9, 10, 11
	Subgroup B-6	Sample/5005	1, 7, 9	
Group D		Sample/5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11	

NOTE:

1. Alternate Group A testing in accordance with Method 5005 of MIL-STD-883 may be exercised.

TABLE 7. TOTAL DOSE IRRADIATION

CONFORMANCE GROUPS	METHOD	TEST		READ AND RECORD	
		PRE RAD	POST RAD	PRE RAD	POST RAD
Group E Subgroup 2	5005	1, 7, 9	Table 4	1, 9	Table 4 (Note 1)

NOTE:

1. Except FN test which will be performed 100% Go/No-Go.

TABLE 8. STATIC AND DYNAMIC BURN-IN TEST CONNECTIONS

OPEN	GROUND	1/2 VCC = 3V ± 0.5V	VCC = 6V ± 0.5V	OSCILLATOR	
				50kHz	25kHz
STATIC BURN-IN I TEST CONNECTIONS (Note 1)					
5, 6, 7	1 - 4, 8 - 15	-	16	-	-
STATIC BURN-IN II TEST CONNECTIONS (Note 1)					
5, 6, 7	8	-	1 - 4, 9 - 16	-	-
DYNAMIC BURN-IN TEST CONDITIONS (Note 2)					
-	1, 8, 10, 11, 13	5, 6, 7	2, 3, 4, 16	12, 15	9, 14

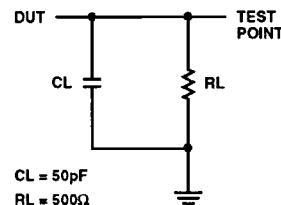
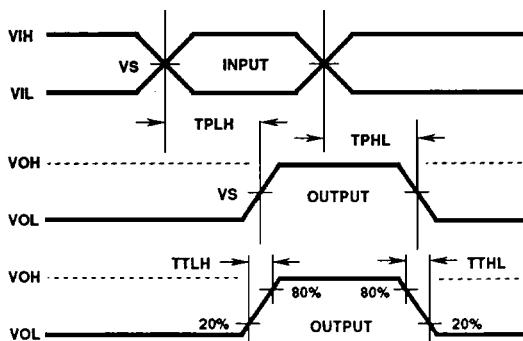
NOTES:

1. Each pin except VCC and GND will have a resistor of $10\text{ k}\Omega \pm 5\%$ for static burn-in.
2. Each pin except VCC and GND will have a resistor of $1\text{ k}\Omega \pm 5\%$ for dynamic burn-in.

TABLE 9. IRRADIATION TEST CONNECTIONS

OPEN	GROUND	VCC = 5V ± 0.5V
5, 6, 7,	8	1 - 4, 9 - 16

NOTE: Each pin except VCC and GND will have a resistor of $47\text{ k}\Omega \pm 5\%$ for irradiation testing.
Group E, Subgroup 2, sample size is 4 dice/wafer 0 failures.

AC Timing Diagrams and Load Circuit

AC VOLTAGE LEVELS

PARAMETER	HCTS	UNITS
VCC	4.50	V
VIH	3.00	V
VS	1.30	V
VIL	0	V
GND	0	V

Die Characteristics**DIE DIMENSIONS:**

100 x 100 mils

METALLIZATION:

Type: SiAl

Metal Thickness: $11\text{k}\text{\AA} \pm 1\text{k}\text{\AA}$ **GLASSIVATION:**Type: SiO_2 Thickness: $13\text{k}\text{\AA} \pm 2.6\text{k}\text{\AA}$ **DIE ATTACH:**

Material: Silver Epoxy

WORST CASE CURRENT DENSITY: $<2.0 \times 10^5 \text{A/cm}^2$ **BOND PAD SIZE:**100 μm x 100 μm

4 mils x 4 mils

Metalization Mask Layout

HCTS85MS

